

BYC20D-600P Hyperfast power diode Rev.01 - 31 May 2018

**Product data sheet** 

### **1. General description**

Hyperfast power diode in a SOD59 (2-lead TO-220AC) plastic package.

#### 2. Features and benefits

- Fast switching
- Low leakage current
- Low reverse recovery current
- Low thermal resistance
- · Reduces switching losses in associated MOSFET or IGBT

### 3. Applications

- Active PFC in air conditioner
- High frequency switched-mode power supplies
- Continuous Current Mode (CCM) Power Factor Correction (PFC)

### 4. Quick reference data

Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating	· · · · · · · · · · · · · · · · · · ·					
$V_{RRM}$	repetitive peak reverse voltage			6	00		V
$I_{F(AV)}$	average forward current	δ = 0.5; T <sub>mb</sub> ≤ 120 °C; square-wave pulse Fig. 1; Fig. 2; Fig. 3	20			A	
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 120 °C; square-wave pulse	40		A		
$I_{FSM}$	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse; Fig. 4	; 250			A	
		$t_{\text{p}}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse	275			А	
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit	
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	- 1.2 1.97		V		
Dynamic	characteristics						
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 200 A/μs; T <sub>i</sub> = 25 °C; <u>Fig. 7</u>		-	16	20	ns

# 5. Pinning information

Table	2.	Pinning	g information	1
Tuble			g innormation	۰.

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	А	anode	۲ O f	К-Ң-А
mb	mb	mounting base; connected to cathode	C () () () () () () () () () ()	001aaa020

# 6. Ordering information

Table 3. Ordering inform	nation		
Type number	Package		
	Name	Description	Version
BYC20D-600P	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59

# 7. Marking

Table 4. Marking codes							
	Type number	Marking codes					
	BYC20D-600P	BYC20D-600P					

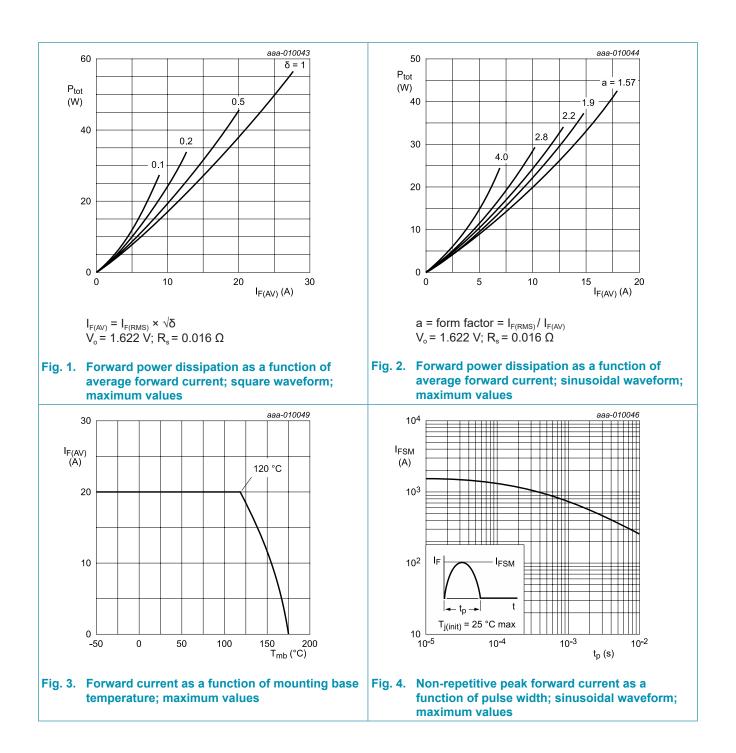
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

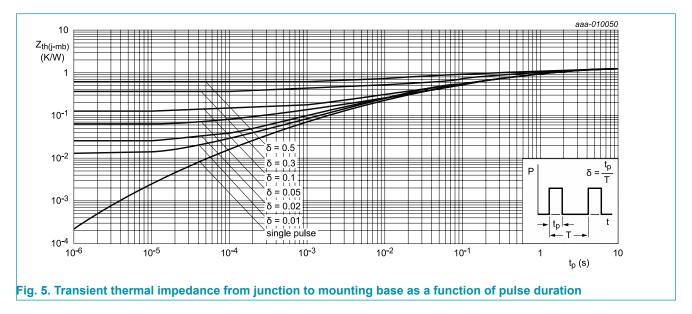
Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
V <sub>RWM</sub>	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; T <sub>mb</sub> ≤ 120 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	20	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 120 °C; square-wave pulse	40	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	250	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	275	А
T <sub>stg</sub>	storage temperature		-65 to 175	°C
Tj	junction temperature		175	°C

BYC20D-600P Hyperfast power diode



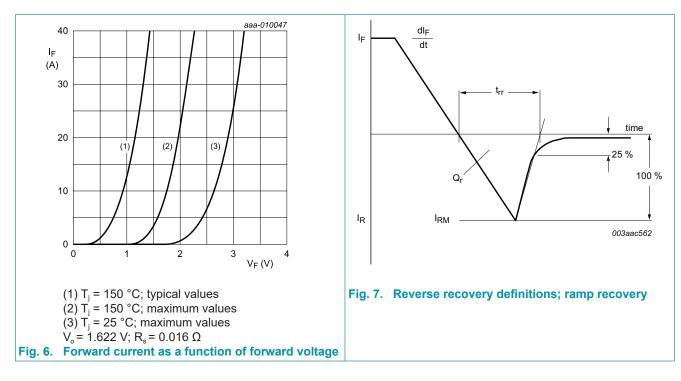
## 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 5	-	-	1.2	K/W
$R_{\text{th}(j\text{-}a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

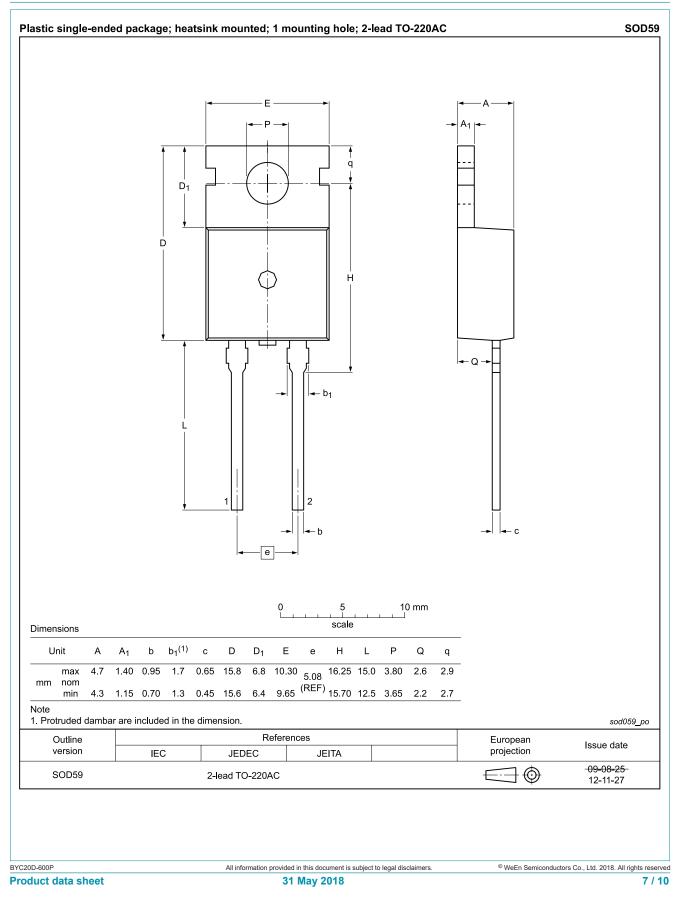


## **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · · · · · · · · · · · · · · · ·			•	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 20A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	2	2.9	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.2	1.97	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	1	mA
Dynamic	characteristics	· · ·				
Q <sub>r</sub>	recovered charge	$I_F = 20 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ µs; $T_j = 25 \text{ °C}; Fig. 7$	-	47	-	nC
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ µs; $T_j = 125 \text{ °C}; Fig. 7$	-	193	-	nC
t <sub>rr</sub>	reverse recovery time	$I_{F} = 1 \text{ A}; V_{R} = 30 \text{ V}; dI_{F}/dt = 200 \text{ A}/\mu\text{s}; T_{j} = 25 \text{ °C}; Fig. 7$	-	16	20	ns
		$ \begin{array}{l} I_{F} = 20 \text{ A};  V_{R} = 400 \text{ V};  dI_{F}/\text{d}t = 500  \text{A}/\mu\text{s}; \\ T_{j} = 25 ^{\circ}\text{C};  \underline{\text{Fig. } 7} \end{array}  $	-	26	-	ns
		$ \begin{array}{l} I_{F} = 20 \text{ A};  V_{R} = 200 \text{ V};  dI_{F}/\text{dt} = 200 \text{ A}/\mu\text{s}; \\ T_{j} = 25 \ ^{\circ}\text{C}; \ \overline{\text{Fig. } 7} \end{array} $	-	33	-	ns
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	51	-	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 20 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	2.8	-	A
		$I_F = 20 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_i = 125 \text{ °C}; Fig. 7$	-	7.6	-	А



### **11. Package outline**



# BYC20D-600P

#### Hyperfast power diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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